



#### **60V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(ON)</sub> max        | I <sub>D</sub> max<br>T <sub>A</sub> = +25°C |
|----------------------|--------------------------------|--|
|                      | 80mΩ @ V <sub>GS</sub> = 10V   | 4.1A   |
| 60V                  | 100mΩ @ V <sub>GS</sub> = 4.5V | 3.6A   |

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- Power Management Functions

**Description and Applications** 

DC-DC Converters

- Low On-Resistance
- Low Input Capacitance

**Features and Benefits** 

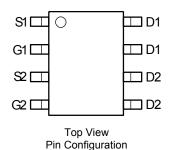
Fast Switching Speed

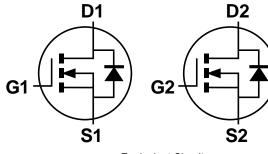
**Mechanical Data** 

Case: SO-8

- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
  - Qualified to AEC-Q101 Standards for High Reliability
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (Approximate)







Equivalent Circuit

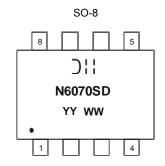
### Ordering Information (Note 4)

| Part Number   | Case | Packaging         |
|---------------|------|-------------------|
| DMN6070SSD-13 | SO-8 | 2,500/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**



);; = Manufacturer's Marking N6070SD = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 13 = 2013) WW = Week (01 - 53)

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#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic  | Symbol          | Value  | Units          |            |   |
|---|-----------------|--|----------------|------------|---|
| Drain-Source Voltage                                    |                 | $V_{DSS}$                                    | 60             | V          |   |
| Gate-Source Voltage                                     |                 | $V_{GSS}$                                    | ±20            | V          |   |
| Continuous Darin Current (Nata C) V - 40V               |                 | $T_A = +25^{\circ}C$<br>$T_A = +70^{\circ}C$ | I <sub>D</sub> | 3.3<br>2.6 | Α |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V | t<10s           | $T_A = +25^{\circ}C$<br>$T_A = +70^{\circ}C$ | I <sub>D</sub> | 4.1<br>3.4 | Α |
| Maximum Continuous Body Diode Forward Current           | (Note 5)        | I <sub>S</sub>                               | 2.0            | Α          |   |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%)      | I <sub>DM</sub> | 12   | Α              |            |   |
| Avalanche Current (Note 7) L=0.1mH                      | I <sub>AS</sub> | 10   | Α              |            |   |
| Avalanche Energy (Note 7) L=0.1mH                       | E <sub>AS</sub> | 5.9  | mJ             |            |   |

## Thermal Characteristics (@T<sub>A</sub>= +25°C, unless otherwise specified.)

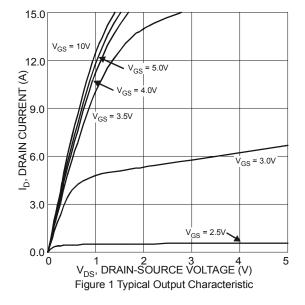
| Characteristic   |       | Symbol                  | Value       | Units |  |
|--|-------|-------------------------|-------------|-------|--|
| Total Power Dissipation (Note 5)                                   |       | $P_{D}$                 | 1.2         | W     |  |
| The second Decision to Australia (Alexa 5) Steady State            |       |                         | 104         | °C/W  |  |
| Thermal Resistance, Junction to Ambient (Note 5)                   | t<10s | t<10s R <sub>0</sub> JA | 61          | ]     |  |
| Total Power Dissipation (Note 6)                                   |       | $P_{D}$                 | 1.5         | W     |  |
| Thermal Resistance, Junction to Ambient (Note 6)  Steady St. t<10s |       | $R_{	hetaJA}$           | 83          |       |  |
|  |       |                         | 50          | °C/W  |  |
| Thermal Resistance, Junction to Case                               |       | $R_{\theta JC}$         | 14.5        |       |  |
| Operating and Storage Temperature Range                            |       | $T_{J_i}T_{STG}$        | -55 to +150 | °C    |  |

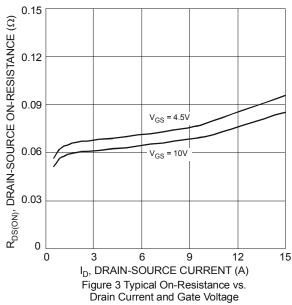
## Electrical Characteristics (@T<sub>A</sub>= +25°C, unless otherwise specified.)

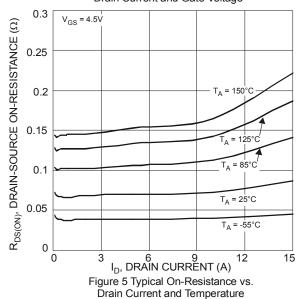
| Characteristic                             | Symbol               | Min | Тур  | Max  | Unit | Test Condition   |  |
|--|----------------------|-----|------|------|------|--|--|
| OFF CHARACTERISTICS (Note 8)               |                      |     |      |      |      |  |  |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>    | 60  | _    | _    | V    | $I_D = 250 \mu A, V_{GS} = 0 V$                        |  |
| Zero Gate Voltage Drain Current            | IDSS                 | _   | _    | 1    | μΑ   | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V            |  |
| Gate-Source Leakage                        | I <sub>GSS</sub>     |     | _    | ±100 | nA   | V <sub>GS</sub> = ±16V, V <sub>DS</sub> = 0V           |  |
| ON CHARACTERISTICS (Note 8)                |                      |     |      | •    |      |  |  |
| Gate Threshold Voltage                     | V <sub>GS(th)</sub>  | 1.0 | _    | 3.0  | V    | $I_D$ = 250 $\mu$ A, $V_{DS}$ = $V_{GS}$               |  |
| Static Drain-Source On-Resistance          |                      |     | 68   | 80   | m0   | V <sub>GS</sub> = 10V, I <sub>D</sub> = 4.5A           |  |
| Static Drain-Source On-Resistance          | R <sub>DS</sub> (ON) | _   | 70   | 100  | mΩ   | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 3.5A          |  |
| Diode Forward Voltage                      | $V_{SD}$             | _   | 0.75 | 1.1  | V    | I <sub>S</sub> = 12A, V <sub>GS</sub> = 0V             |  |
| DYNAMIC CHARACTERISTICS (Note 9)           |                      |     |      |      |      |  |  |
| Input Capacitance                          | C <sub>iss</sub>     |     | 588  | _    |      | ), oo, , , , o, ,                                      |  |
| Output Capacitance                         | Coss                 |     | 26.5 | _    | pF   | V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V<br>f= 1MHz |  |
| Reverse Transfer Capacitance               | Crss                 |     | 20   | _    |      | I- IIVIIIZ   |  |
| Gate Resistance                            | $R_g$                | _   | 1.5  | _    | Ω    | Vgs= 0V, Vds= 0V, f=1MHz,                              |  |
| Total Gate Charge (V <sub>GS</sub> = 4.5V) | $Q_g$                | _   | 5.6  | _    |      |  |  |
| Total Gate Charge (V <sub>GS</sub> = 10V)  |                      |     | 12.3 | _    | nC   | \\ - 20\\ I - 24                                       |  |
| Gate-Source Charge                         | Q <sub>gs</sub>      |     | 1.7  | _    | IIC  | V <sub>DS</sub> = 30V, I <sub>D</sub> = 3A             |  |
| Gate-Drain Charge                          | $Q_{gd}$             | _   | 1.9  | _    |      |  |  |
| Turn-On Delay Time                         | t <sub>D(on)</sub>   | _   | 3.5  | _    |      |  |  |
| Turn-On Rise Time                          | t <sub>r</sub>       | _   | 4.1  | _    | nS   | V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V           |  |
| Turn-Off Delay Time                        | t <sub>D(off)</sub>  |     | 35   | _    | no   | $R_L \cong 50\Omega, R_G \cong 20\Omega$               |  |
| Turn-Off Fall Time                         | t <sub>f</sub>       | _   | 11   | _    |      |  |  |
| Body Diode Reverse Recovery Time           | trr                  | _   | 18   | _    | nS   | I <sub>S</sub> = 12A, dI/dt = 100A/μs                  |  |
| Body Diode Reverse Recovery Charge         | Qrr                  |     | 12   |      | nC   | I <sub>S</sub> = 12A, dI/dt = 100A/μs                  |  |

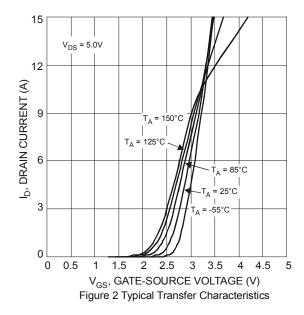
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 7.  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_{J}$  = +25°C. 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.

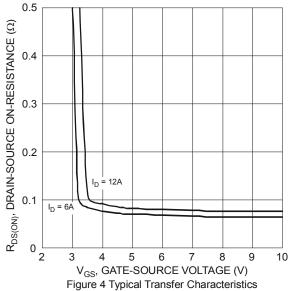


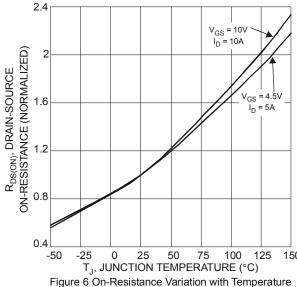




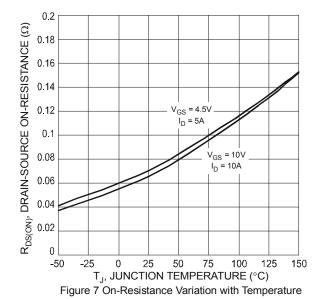


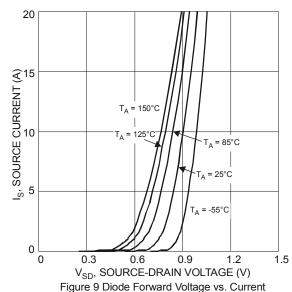


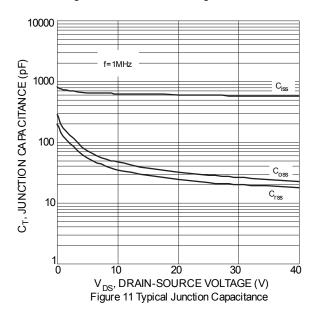












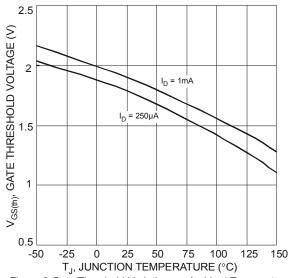
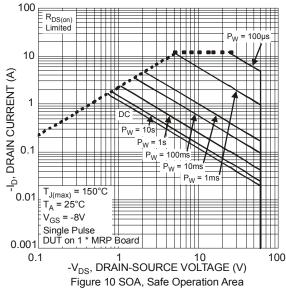
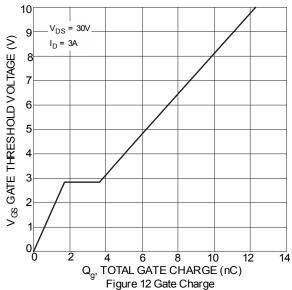
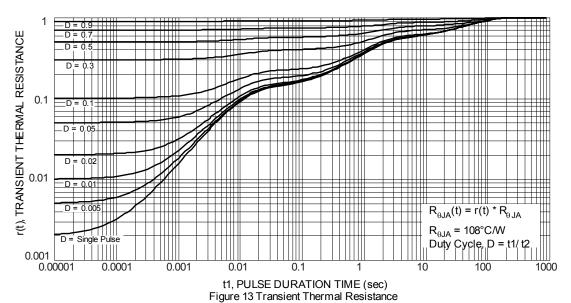


Figure 8 Gate Threshold Variation vs. Ambient Temperature



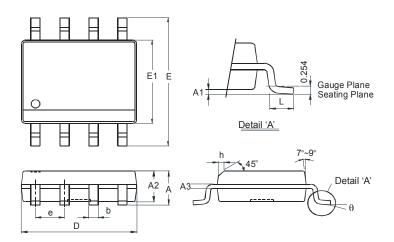






## **Package Outline Dimensions**

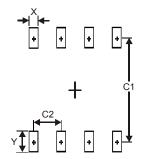
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| SO-8                 |           |      |  |  |  |
|----------------------|-----------|------|--|--|--|
| Dim                  | Min       | Max  |  |  |  |
| Α                    | -         | 1.75 |  |  |  |
| A1                   | 0.10      | 0.20 |  |  |  |
| A2                   | 1.30      | 1.50 |  |  |  |
| А3                   | 0.15      | 0.25 |  |  |  |
| b                    | 0.3       | 0.5  |  |  |  |
| D                    | 4.85      | 4.95 |  |  |  |
| Е                    | 5.90      | 6.10 |  |  |  |
| E1                   | 3.85 3.95 |      |  |  |  |
| е                    | 1.27      | Тур  |  |  |  |
| h                    | - 0.35    |      |  |  |  |
| ٦                    | 0.62      | 0.82 |  |  |  |
| θ                    | 0°        | 8°   |  |  |  |
| All Dimensions in mm |           |      |  |  |  |

#### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |  |  |  |
|------------|---------------|--|--|--|
| Х          | 0.60          |  |  |  |
| Y          | 1.55          |  |  |  |
| C1         | 5.4           |  |  |  |
| C2         | 1.27          |  |  |  |



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